

Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic			Symbol	Value	Unit
Drain-Source Voltage			V_{DSS}	50	V
Gate-Source Voltage			V_{GSS}	±20	V
Continuous Drain Current (Note 6) V _{GS} = 10V	Steady State	$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	ΙD	0.31 0.25	Α
Maximum Continuous Body Diode Forward Current (Note 6)			I _S	0.5	Α
Pulsed Drain Current (10μs Pulse, Duty Cycle = 1%)			I _{DM}	0.8	А

Thermal Characteristics

Characteristic		Symbol	Value	Unit
Total Power Dissipation (Note 5)		P_{D}	0.38	W
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	R _{0JA}	338	°C/W
Total Power Dissipation (Note 6)		P _D	0.54	W
Thermal Resistance, Junction to Ambient (Note 6)	Steady State	R _{0JA}	237	°C/W
Operating and Storage Temperature Range		T _{J,} T _{STG}	-55 to +150	°C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

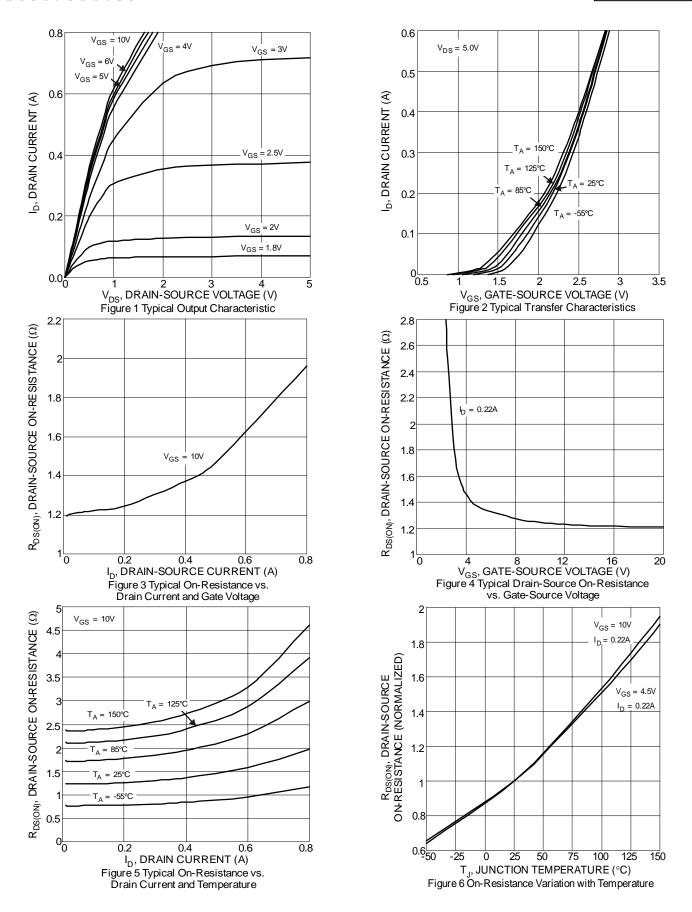
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 7)							
Drain-Source Breakdown Voltage	BV _{DSS}	50		_	V	$V_{GS} = 0V, I_D = 250\mu A$	
Zero Gate Voltage Drain Current T _J = +25°C	I _{DSS}	_		1	μΑ	$V_{DS} = 50V, V_{GS} = 0V$	
Gate-Source Leakage	IGSS	_	_	±10	μΑ	$V_{GS} = \pm 20V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 7)							
Gate Threshold Voltage	V _{GS(TH)}	0.5	1.1	1.5	V	$V_{DS} = V_{GS}$, $I_D = 250\mu A$	
Static Drain-Source On-Resistance	R _{DS(ON)}	_	1.3	3.5	Ω	$V_{GS} = 10V, I_D = 0.22A$	
Diode Forward Voltage	V_{SD}	_	0.8	1.2	V	$V_{GS} = 0V, I_D = 0.22A$	
DYNAMIC CHARACTERISTICS (Note 8)						_	
Input Capacitance	Ciss	_	23.2	_	pF	V _{DS} = 25V, V _{GS} = 0V -f = 1.0MHz	
Output Capacitance	Coss	_	3.1	_	pF		
Reverse Transfer Capacitance	C _{rss}	_	2.2	_	pF		
Gate Resistance	R_g		69	_	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$	
Total Gate Charge (V _{GS} = 4.5V)	Q_g		0.45	_	nC	V _{DS} = 25V, I _D = 0.2A	
Total Gate Charge (V _{GS} = 10V)	Q_g	_	0.95	_	nC		
Gate-Source Charge	Q_{gs}	_	0.10	_	nC		
Gate-Drain Charge	Q_{gd}	_	0.14	_	nC		
Turn-On Delay Time	t _{D(ON)}	_	3.2	_	ns	$V_{DS} = 25V$, $V_{GS} = 10V$, $R_{G} = 50\Omega$, $I_{D} = 0.2A$	
Turn-On Rise Time	t _R	_	2.5	_	ns		
Turn-Off Delay Time	t _{D(OFF)}	_	13.8	_	ns		
Turn-Off Fall Time	t _F	_	7.6	_	ns		
Reverse Recovery Time	t _{RR}	_	8.8	_	ns	$I_F = 0.2A$, $di/dt = 100A/\mu s$	
Reverse Recovery Charge	Q _{RR}	_	2.6	_	nC	$I_F = 0.2A$, $di/dt = 100A/\mu s$	

Notes: 5. Device mounted on FR-4 PCB, with minimum recommended pad layout.

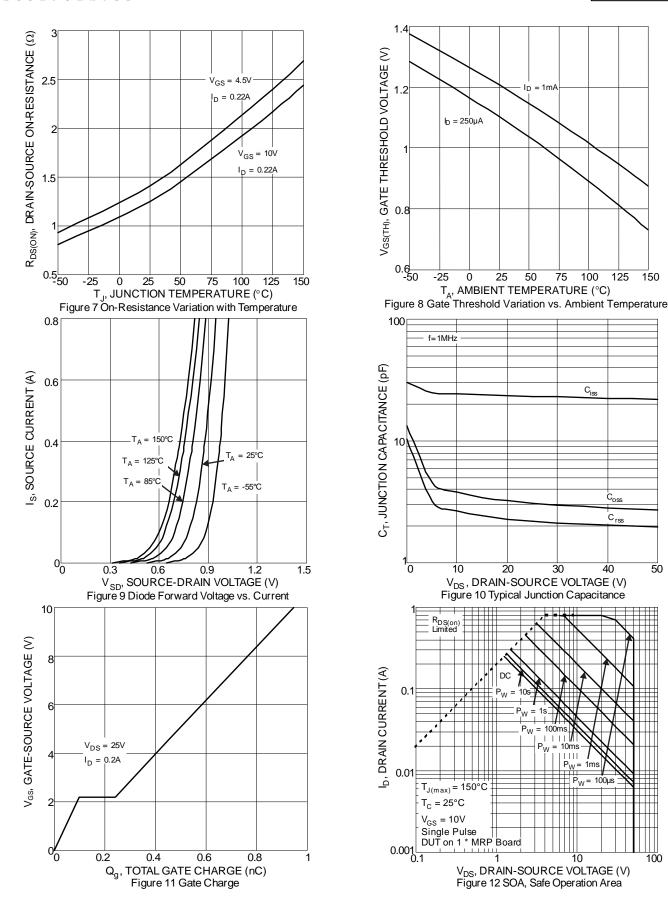
6. Device mounted on 1" x 1" FR-4 PCB with high coverage 2oz. Copper, single sided. 7. Short duration pulse test used to minimize self-heating effect.

^{8.} Guaranteed by design. Not subject to product testing.





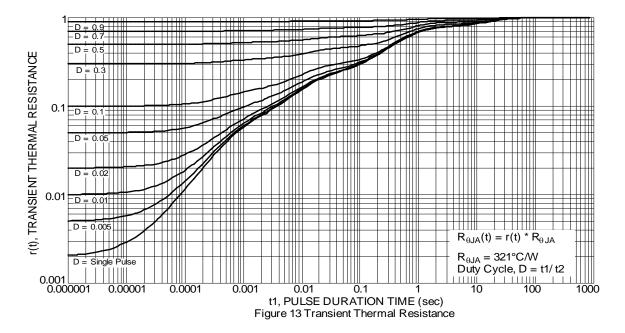




100

50



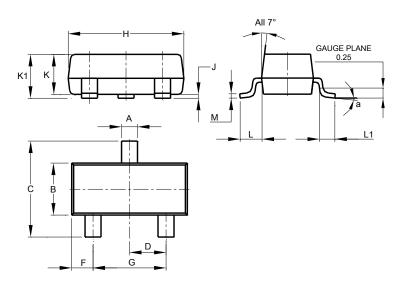




Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

SOT23

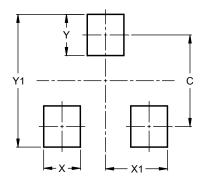


SOT23					
Dim	Min	Max	Тур		
Α	0.37	0.51	0.40		
В	1.20	1.40	1.30		
С	2.30	2.50	2.40		
D	0.89	1.03	0.915		
F	0.45	0.60	0.535		
G	1.78	2.05	1.83		
Н	2.80	3.00	2.90		
J	0.013	0.10	0.05		
K	0.890	1.00	0.975		
K1	0.903	1.10	1.025		
L	0.45	0.61	0.55		
L1	0.25	0.55	0.40		
M	0.085	0.150	0.110		
а	0°	8°			
All Dimensions in mm					

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

SOT23



Dimensions	Value (in mm)
С	2.0
X	0.8
X1	1.35
Y	0.9
Y1	2.9



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